Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

PIC16(L)F1825/9

14/20-Pin Flash Microcontrollers with XLP Technology

High-Performance RISC CPU

- Only 49 Instructions to Learn:
  - All single-cycle instructions except branches
- Operating Speed:
  - DC – 32 MHz oscillator/clock input
  - DC – 125 ns instruction cycle
- Up to 16 Kbytes Linear Program Memory Addressing
- Up to 1024 bytes Linear Data Memory Addressing
- Interrupt Capability with Automatic Context Saving
- 16-Level Deep Hardware Stack with Optional Overflow/Underflow Reset
- Direct, Indirect and Relative Addressing modes:
  - Two full 16-bit File Select Registers (FSRs)
  - FSRs can read program and data memory

Flexible Oscillator Structure

- Precision 32 MHz Internal Oscillator Block:
  - Factory calibrated to ± 1%, typical
  - Software selectable frequencies range of 31 kHz to 32 MHz
- 31 kHz Low-Power Internal Oscillator
- Four Crystal modes up to 32 MHz
- Three External Clock modes up to 32 MHz
- 4x Phase Lock Loop (PLL)
- Fail-Safe Clock Monitor:
  - Allows for safe shutdown if peripheral clock stops
- Two-Speed Oscillator Start-Up
- Reference Clock Module:
  - Programmable clock output frequency and duty cycle

Special Microcontroller Features

- 1.8V-5.5V Operation – PIC16F1825/9
- 1.8V-3.6V Operation – PIC16LF1825/9
- Self-Programmable under Software Control
- Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Programmable Brown-out Reset (BOR)
- Extended Watchdog Timer (WDT)
- In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug (ICD) via Two Pins
- Enhanced Low-Voltage Programming (LVP)
- Programmable Code Protection
- Power-Saving Sleep mode

Extreme Low-Power Management PIC16LF1825/9 with XLP

- Sleep mode: 20 nA @ 1.8V, typical
- Watchdog Timer: 300 nA @ 1.8V, typical
- Timer1 Oscillator: 650 nA @ 32 kHz, 1.8V, typical
- Operating Current: 48 µA/MHz @ 1.8V, typical

Analog Features

- Analog-to-Digital Converter (ADC) Module:
  - 10-bit resolution, up to 12 channels
  - Auto acquisition capability
  - Conversion available during Sleep
- Analog Comparator Module:
  - Two rail-to-rail analog comparators
  - Power mode control
  - Software controllable hysteresis
- Voltage Reference Module:
  - Fixed Voltage Reference (FVR) with 1.024V, 2.048V and 4.096V output levels
  - 5-bit rail-to-rail resistive DAC with positive and negative reference selection

Peripheral Highlights

- Up to 17 I/O Pins and 1 Input Only Pin:
  - High current sink/source 25 mA/25 mA
  - Programmable weak pull-ups
  - Programmable interrupt-on-change pins
- Timer0: 8-Bit Timer/Counter with 8-Bit Prescaler
- Enhanced Timer1:
  - 16-bit timer/counter with prescaler
  - External Gate Input mode
  - Dedicated, low-power 32 kHz oscillator driver
- Three Timer2-types: 8-Bit Timer/Counter with 8-Bit Period Register, Prescaler and Postscaler
- Two Capture, Compare, PWM (CCP) Modules
- Two Enhanced CCP (ECCP) Modules:
  - Software selectable time bases
  - Auto-shutdown and auto-restart
  - PWM steering
- Up to Two Master Synchronous Serial Port (MSSP) with SPI and I^2C™ with:
  - 7-bit address masking
  - SMBus/PMBus™ compatibility
- Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) Module
- mTouch™ Sensing Oscillator Module:
  - Up to 12 input channels

Peripheral Highlights (Continued)

- Data Signal Modulator Module:
  - Selectable modulator and carrier sources
- SR Latch:
  - Multiple Set/Reset input options
  - Emulates 555 Timer applications

PIC12(L)F1822/1840/PIC16(L)F182x/1847 Family Types

Device	Data Sheet Index	Program Memory Flash (words)	Data EEPROM (bytes)	Data SRAM (bytes)	I/O's(2)	10-bit ADC (ch)	CapSense (ch)	Comparators	Timers (8/16-bit)	EUSART	MSSP (I^2C™/SPI)	ECCP (Full-Bridge) ECCP (Half-Bridge) CCP	SR Latch	Debug(1)	XLP
PIC12(L)F1822	(1)	2K	256	128	6	4	4	1	2/1	1	1	0/1/0	Y	I/H	Y
PIC12(L)F1840	(2)	4K	256	256	6	4	4	1	2/1	1	1	0/1/0	Y	I/H	Y
PIC16(L)F1823	(1)	2K	256	128	12	8	8	2	2/1	1	1	1/0/0	Y	I/H	Y
PIC16(L)F1824	(3)	4K	256	256	12	8	8	2	4/1	1	1	1/1/2	Y	I/H	Y
PIC16(L)F1825	(4)	8K	256	1024	12	8	8	2	4/1	1	1	1/1/2	Y	I/H	Y
PIC16(L)F1826	(5)	2K	256	256	16	12	12	2	2/1	1	1	1/0/0	Y	I/H	Y
PIC16(L)F1827	(5)	4K	256	384	16	12	12	2	4/1	1	2	1/1/2	Y	I/H	Y
PIC16(L)F1828	(3)	4K	256	256	18	12	12	2	4/1	1	1	1/1/2	Y	I/H	Y
PIC16(L)F1829	(4)	8K	256	1024	18	12	12	2	4/1	1	2	1/1/2	Y	I/H	Y
PIC16(L)F1847	(6)	8K	256	1024	16	12	12	2	4/1	1	2	1/1/2	Y	I/H	Y

Note 1: I - Debugging, Integrated on Chip; H - Debugging, available using Debug Header.

2: One pin is input-only.

Data Sheet Index: (Unshaded devices are described in this document.)

1: DS41413 PIC12(L)F1822/PIC16(L)F1823 Data Sheet, 8/14-Pin Flash Microcontrollers.

2: DS41441 PIC12(L)F1840 Data Sheet, 8-Pin Flash Microcontrollers.

3: DS41419 PIC16(L)F1824/1828 Data Sheet, 28/40/44-Pin Flash Microcontrollers.

4: DS41440 PIC16(L)F1825/1829 Data Sheet, 14/20-Pin Flash Microcontrollers.

5: DS41391 PIC16(L)F1826/1827 Data Sheet, 18/20/28-Pin Flash Microcontrollers.

6: DS41453 PIC16(L)F1847 Data Sheet, 18/20/28-Pin Flash Microcontrollers.

Note: For other small form-factor package availability and marking information, please visit www.microchip.com/packaging or contact your local sales office.

FIGURE 1: 14-PIN DIAGRAM FOR PIC16(L)F1825

PDIP, SOIC, TSSOP

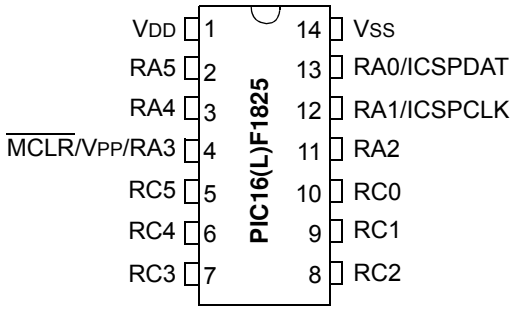


FIGURE 2: 16-PIN DIAGRAM FOR PIC16(L)F1825

QFN, UQFN

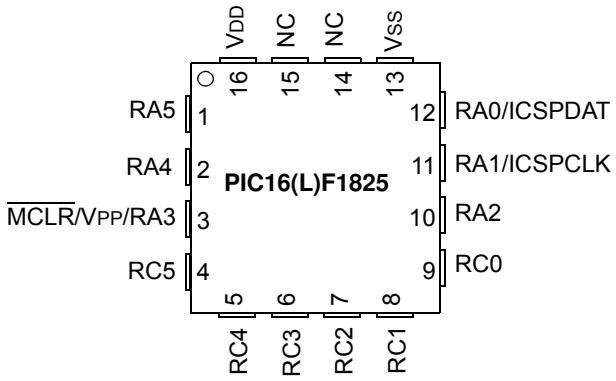


TABLE 1: 14-PIN AND 16-PIN ALLOCATION TABLE (PIC16(L)F1825)

I/O	14-Pin PDIP/SOIC/TSSOP	16-Pin QFN/UQFN	A/D	Reference	Cap Sense	Comparator	SR Latch	Timers	ECCP	EUSART	MSSP	Interrupt	Modulator	Pull-up	Basic
RA0	13	12	AN0	VREF- DACOUT	CPS0	C1IN+	—	—	—	TX(1) CK(1)	—	IOC	—	Y	ICSPDAT ICDDAT
RA1	12	11	AN1	VREF+	CPS1	C12IN0-	SRI	—	—	RX(1) DT(1)	—	IOC	—	Y	ICSPCLK ICDCLK
RA2	11	10	AN2	—	CPS2	C1OUT	SRQ	T0CKI	CCP3 FLT0	—	—	INT/ IOC	—	Y	—
RA3	4	3	—	—	—	—	—	T1G(1)	—	—	$\overline{SS1}$(1)	IOC	—	Y	$\overline{MCLR}$ VPP
RA4	3	2	AN3	—	CPS3	—	—	T1G(1) T1OSO	P2B(1)	—	SDO1(1)	IOC	—	Y	OSC2 CLKOUT CLKR
RA5	2	1	—	—	—	—	—	T1CKI T1OSI	CCP2 P2A(1)	—	—	IOC	—	Y	OSC1 CLKIN
RC0	10	9	AN4	—	CPS4	C2IN+	—	—	P1D(1)	—	SCL SCK	—	—	Y	—
RC1	9	8	AN5	—	CPS5	C12IN1-	—	—	CCP4 P1C(1)	—	SDA SDI	—	—	Y	—
RC2	8	7	AN6	—	CPS6	C12IN2-	—	—	P1D(1) P2B(1)	—	SDO1(1)	—	MDCIN1	Y	—
RC3	7	6	AN7	—	CPS7	C12IN3-	—	—	CCP2(1) P1C(1) P2A(1)	—	$\overline{SS1}$(1)	—	MDMIN	Y	—
RC4	6	5	—	—	—	C2OUT	SRNQ	—	P1B	TX(1) CK(1)	—	—	MDOUT	Y	—
RC5	5	4	—	—	—	—	—	—	CCP1 P1A	RX(1) DT(1)	—	—	MDCIN2	Y	—
VDD	1	16	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	14	13	—	—	—	—	—	—	—	—	—	—	—	—	VSS

Note 1: Pin function is selectable via the APFCON0 or APFCON1 register.

FIGURE 3: 20-PIN DIAGRAM FOR PIC16(L)F1829

PDIP, SOIC, SSOP

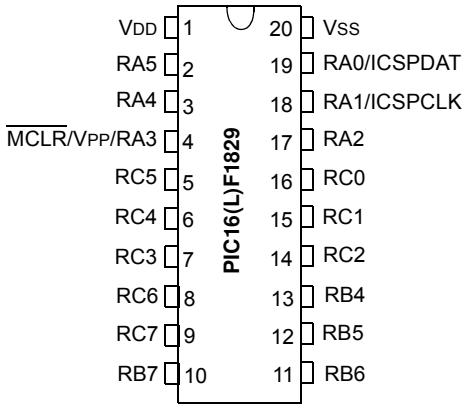


FIGURE 4: 20-PIN DIAGRAM FOR PIC16(L)F1829

QFN, UQFN

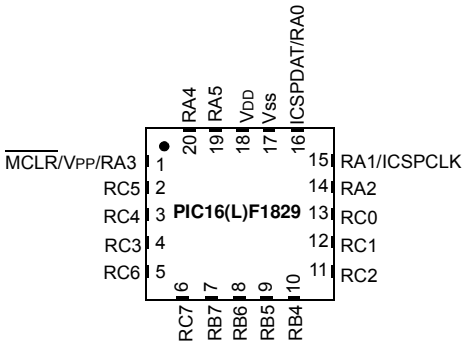


TABLE 2: 20-PIN ALLOCATION TABLE (PIC16(L)F1829)

I/O	20-Pin PDIP/SOIC/SSOP	20-Pin QFN/UQFN	A/D	Reference	Cap Sense	Comparator	SR Latch	Timers	CCP	EUSART	SSP	Interrupt	Modulator	Pull-up	Basic
RA0	19	16	AN0	VREF- DACOUT	CPS0	C1IN+	—	—	—	—	—	IOC	—	Y	ICSPDAT/ ICDDAT
RA1	18	15	AN1	VREF+	CPS1	C12IN0-	SRI	—	—	—	—	IOC	—	Y	ICSPCLK/ ICDCLK
RA2	17	14	AN2	—	CPS2	C1OUT	SRQ	T0CKI	CCP3 FLT0	—	—	INT/ IOC	—	Y	—
RA3	4	1		—	—	—	—	T1G(1)	—	—	—	IOC	—	Y(4)	$\overline{\text{MCLR}}$ VPP
RA4	3	20	AN3	—	CPS3	—	—	T1G(1) T1OSO	P2B(1)	—	$\overline{\text{SS2}}$(1)	IOC	—	Y	OSC2 CLKOUT CLKR
RA5	2	19	—	—	—	—	—	T1CKI T1OSI	CCP2(1) P2A(1)	—	SDO2(1)	IOC	—	Y	OSC1 CLKIN
RB4	13	10	AN10	—	CPS10	—		—	—	—	SDA1 SDI1	IOC	—	Y	—
RB5	12	9	AN11	—	CPS11	—	—	—	—	RX(1) DT(1)	SDA2 SDI2	IOC	—	Y	—
RB6	11	8	—	—	—	—	—	—	—	—	SCL1 SCK1	IOC	—	Y	—
RB7	10	7	—	—	—	—	—	—	—	TX(1) CK(1)	SCL2 SCK2	IOC	—	Y	—
RC0	16	13	AN4	—	CPS4	C2IN+	—	—	P1D(1)	—	$\overline{\text{SS2}}$(1)	—	—	Y	—
RC1	15	12	AN5	—	CPS5	C12IN1-	—	—	P1C(1)	—	SDO2(1)	—	—	Y	—
RC2	14	11	AN6	—	CPS6	C12IN2-	—	—	P1D(1) P2B(1)	—	—	—	MDCIN1	Y	—
RC3	7	4	AN7	—	CPS7	C12IN3-	—	—	P1C(1) CCP2(1) P2A(1)	—	—	—	MDMIN	Y	—
RC4	6	3	—	—	—	C2OUT	SRNQ	—	P1B	TX(1) CK(1)	—	—	MDOUT	Y	—
RC5	5	2	—	—	—	—	—	—	CCP1 P1A	RX(1) DT(1)	—	—	MDCIN2	Y	—
RC6	8	5	AN8	—	CPS8	—	—	—	CCP4	—	$\overline{\text{SS1}}$	—	—	Y	—
RC7	9	6	AN9	—	CPS9	—	—	—	—	—	SDO1	—	—	Y	—
VDD	1	18	—	—	—	—	—	—	—	—	—	—	—	—	VDD
Vss	20	17	—	—	—	—	—	—	—	—	—	—	—	—	Vss

Note 1: Pin function is selectable via the APFCON0 or APFCON1 register.

Table of Contents

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at **docerrors@microchip.com**. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; **http://www.microchip.com**
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at **www.microchip.com** to receive the most current information on all of our products.

1.0 DEVICE OVERVIEW

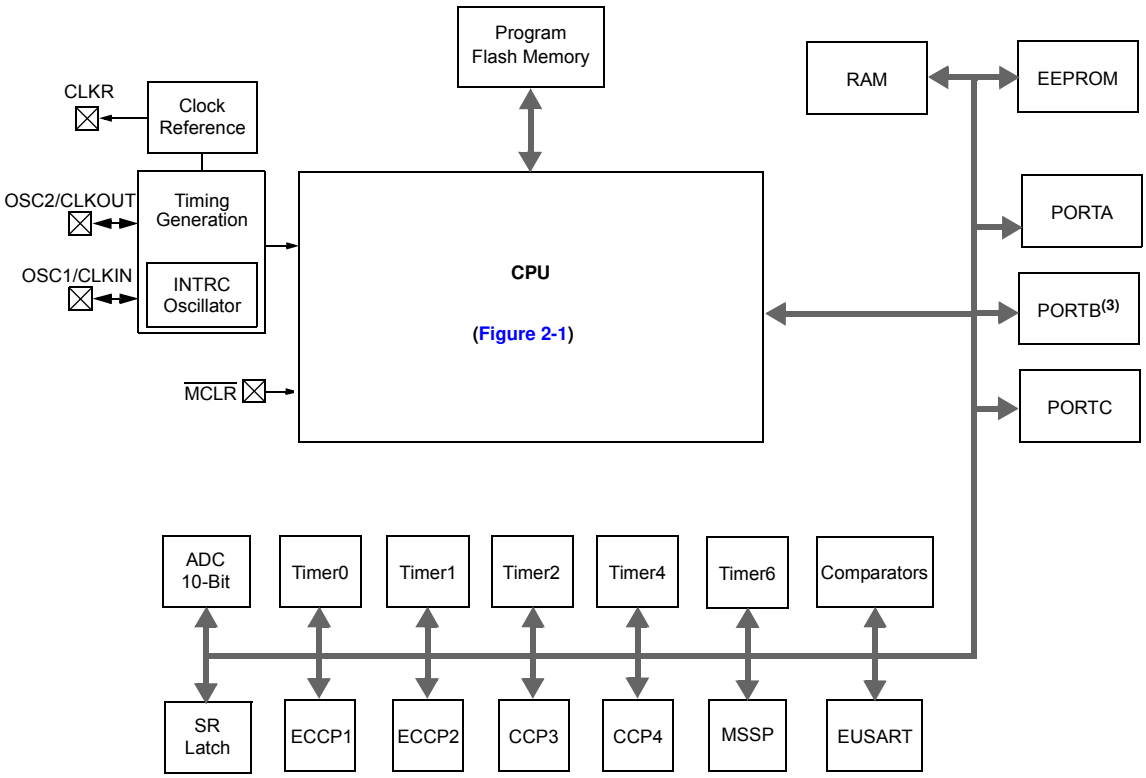
The PIC16(L)F1825/9 are described within this data sheet. They are available in 14/20 pin packages. Figure 1-1 shows a block diagram of the PIC16(L)F1825/9 devices. Tables 1-2 and 1-3 show the pinout descriptions.

Reference Table 1-1 for peripherals available per device.

TABLE 1-1: DEVICE PERIPHERAL SUMMARY

Peripheral		PIC16(L)F1825	PIC16(L)F1829
ADC		●	●
Capacitive Sensing (CPS) Module		●	●
Data EEPROM		●	●
Digital-to-Analog Converter (DAC)		●	●
Digital Signal Modulator (DSM)		●	●
EUSART		●	●
Fixed Voltage Reference (FVR)		●	●
SR Latch		●	●
Capture/Compare/PWM Modules			
	ECCP1	●	●
	ECCP2	●	●
	CCP3	●	●
	CCP4	●	●
Comparators			
	C1	●	●
	C2	●	●
Master Synchronous Serial Ports			
	MSSP1	●	●
	MSSP2		●
Timers			
	Timer0	●	●
	Timer1	●	●
	Timer2	●	●
	Timer4	●	●
	Timer6	●	●

FIGURE 1-1: PIC16(L)F1825/9 BLOCK DIAGRAM



Note 1: See applicable chapters for more information on peripherals.
2: See Table 1-1 for peripherals available on specific devices.
3: PIC16(L)F1829 only.

TABLE 1-2: PIC16(L)F1825 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/CPS0/C1IN+/VREF-/ DACOUT/TX(1)/CK(1)/ ICSPDAT/ICDDAT	RA0	TTL	CMOS	General purpose I/O.
	AN0	AN	—	A/D Channel 0 input.
	CPS0	AN	—	Capacitive sensing input 0.
	C1IN+	AN	—	Comparator C1 positive input.
	VREF-	AN	—	A/D and DAC Negative Voltage Reference input.
	DACOUT	—	AN	Digital-to-Analog Converter output.
	TX	—	CMOS	USART asynchronous transmit.
	CK	ST	CMOS	USART synchronous clock.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
	ICDDAT	ST	CMOS	In-Circuit Data I/O.
RA1/AN1/CPS1/C12IN0-/VREF+/ SRI/RX(1)/DT(1)/ICSPCLK/ ICDCLK	RA1	TTL	CMOS	General purpose I/O.
	AN1	AN	—	A/D Channel 1 input.
	CPS1	AN	—	Capacitive sensing input 1.
	C12IN0-	AN	—	Comparator C1 or C2 negative input.
	VREF+	AN	—	A/D and DAC Positive Voltage Reference input.
	SRI	ST	—	SR Latch input.
	RX	ST	—	USART asynchronous input.
	DT	ST	CMOS	USART synchronous data.
	ICSPCLK	ST	—	Serial Programming Clock.
	ICDCLK	ST	—	In-Circuit Debug Clock.
RA2/AN2/CPS2/T0CKI/INT/ C1OUT/SRQ/CCP3/FLT0	RA2	ST	CMOS	General purpose I/O.
	AN2	AN	—	A/D Channel 2 input.
	CPS2	AN	—	Capacitive sensing input 2.
	T0CKI	ST	—	Timer0 clock input.
	INT	ST	—	External interrupt.
	C1OUT	—	CMOS	Comparator C1 output.
	SRQ	—	CMOS	SR Latch non-inverting output.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	FLT0	ST	—	ECCP Auto-Shutdown Fault input.
RA3/$\overline{SS1}$(1)/T1G(1)/VPP/$\overline{MCLR}$	RA3	TTL	—	General purpose input.
	$\overline{SS1}$	ST	—	Slave Select input.
	T1G	ST	—	Timer1 Gate input.
	VPP	HV	—	Programming voltage.
	$\overline{MCLR}$	ST	—	Master Clear with internal pull-up.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

TABLE 1-2: PIC16(L)F1825 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RA4/AN3/CPS3/OSC2/ CLKOUT/T1OSO/CLKR/ SDO1(1)/P2B(1)/T1G(1,2)	RA4	TTL	CMOS	General purpose I/O.
	AN3	AN	—	A/D Channel 3 input.
	CPS3	AN	—	Capacitive sensing input 3.
	OSC2	—	CMOS	Comparator C2 output.
	CLKOUT	—	CMOS	FOSC/4 output.
	T1OSO	XTAL	XTAL	Timer1 oscillator connection.
	CLKR	—	CMOS	Clock Reference output.
	SDO1	—	CMOS	SPI data output.
	P2B	—	CMOS	PWM output.
	T1G	ST	—	Timer1 Gate input.
RA5/CLKIN/OSC1/T1OSI/ T1CKI/P2A(1)/CCP2(1)	RA5	TTL	CMOS	General purpose I/O.
	CLKIN	CMOS	—	External clock input (EC mode).
	OSC1	XTAL	—	Crystal/Resonator (LP, XT, HS modes).
	T1OSI	XTAL	XTAL	Timer1 oscillator connection.
	T1CKI	ST	—	Timer1 clock input.
	P2A	—	CMOS	PWM output.
	CCP2	ST	CMOS	Capture/Compare/PWM2.
RC0/AN4/CPS4/C2IN+/SCL/ SCK/P1D(1)	RC0	TTL	CMOS	General purpose I/O.
	AN4	AN	—	A/D Channel 4 input.
	CPS4	AN	—	Capacitive sensing input 4.
	C2IN+	AN	—	Comparator C2 positive input.
	SCL	I^2C	OD	I^2C™ clock.
	SCK	ST	CMOS	SPI clock.
	P1D	—	CMOS	PWM output.
RC1/AN5/CPS5/C12IN1-/SDA/ SDI/P1C(1)/CCP4	RC1	TTL	CMOS	General purpose I/O.
	AN5	AN	—	A/D Channel 5 input.
	CPS5	AN	—	Capacitive sensing input 5.
	C12IN1-	AN	—	Comparator C1 or C2 negative input.
	SDA	I^2C	OD	I^2C data input/output.
	SDI	CMOS	—	SPI data input.
	P1C	—	CMOS	PWM output.
	CCP4	AN	—	Capture/Compare/PWM4.
RC2/AN6/CPS6/C12IN2-/ P1D(1,2)/P2B(1,2)/SDO1(1,2)/ MDCIN1	RC2	TTL	CMOS	General purpose I/O.
	AN6	AN	—	A/D Channel 6 input.
	CPS6	AN	—	Capacitive sensing input 6.
	C12IN2-	AN	—	Comparator C1 or C2 negative input.
	P1D	—	CMOS	PWM output.
	P2B	—	CMOS	PWM output.
	SDO1	—	CMOS	SPI data output.
	MDCIN1	ST	—	Modulator Carrier Input 1.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open Drain
TTL = TTL compatible input; ST = Schmitt Trigger input with CMOS levels; I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage; XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

TABLE 1-2: PIC16(L)F1825 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC3/AN7/CPS7/C12IN3-/ P2A(1,2)/CCP2(1,2)/P1C(1,2)/ $\overline{SS1}$(1,2)/MDMIN	RC3	TTL	CMOS	General purpose I/O.
	AN7	AN	—	A/D Channel 7 input.
	CPS7	AN	—	Capacitive sensing input 7.
	C12IN3-	AN	—	Comparator C1 or C2 negative input.
	P2A	—	CMOS	PWM output.
	CCP2	AN	—	Capture/Compare/PWM2.
	P1C	—	CMOS	PWM output.
	$\overline{SS1}$	ST	—	Slave Select input.
	MDMIN	ST	—	Modulator source input.
RC4/C2OUT/SRNQ/P1B/TX(1,2)/ CK(1,2)/MDOUT	RC4	TTL	CMOS	General purpose I/O.
	C2OUT	—	CMOS	Comparator C2 output.
	SRNQ	—	CMOS	SR Latch inverting output.
	P1B	—	CMOS	PWM output.
	TX	—	CMOS	USART asynchronous transmit.
	CK	ST	CMOS	USART synchronous clock.
	MDOUT	—	CMOS	Modulator output.
RC5/P1A/CCP1/DT(1,2)/RX(1,2)/ MDCIN2	RC5	TTL	CMOS	General purpose I/O.
	P1A	—	CMOS	PWM output.
	CCP1	ST	CMOS	Capture/Compare/PWM1.
	RX	ST	—	USART asynchronous input.
	DT	ST	CMOS	USART synchronous data.
	MDCIN2	ST	—	Modulator Carrier Input 2.
VDD	VDD	Power	—	Positive supply.
VSS	VSS	Power	—	Ground reference.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

TABLE 1-3: PIC16(L)F1829 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/CPS0/C1IN+/VREF-/ DACOUT/ICSPDAT/ICDDAT	RA0	TTL	CMOS	General purpose I/O.
	AN0	AN	—	A/D Channel 0 input.
	CPS0	AN	—	Capacitive sensing input 0.
	C1IN+	AN	—	Comparator C1 positive input.
	VREF-	AN	—	A/D and DAC Negative Voltage Reference input.
	DACOUT	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
	ICDDAT	ST	CMOS	In-Circuit Data I/O.
RA1/AN1/CPS1/C12IN0-/VREF+/ SRI/ICSPCLK/ICDCLK	RA1	TTL	CMOS	General purpose I/O.
	AN1	AN	—	A/D Channel 1 input.
	CPS1	AN	—	Capacitive sensing input 1.
	C12IN0-	AN	—	Comparator C1 or C2 negative input.
	VREF+	AN	—	A/D and DAC Positive Voltage Reference input.
	SRI	ST	—	SR Latch input.
	ICSPCLK	ST	—	Serial Programming Clock.
	ICDCLK	ST	—	In-Circuit Debug Clock.
RA2/AN2/CPS2/T0CKI/INT/ C1OUT/SRQ/CCP3/FLT0	RA2	ST	CMOS	General purpose I/O.
	AN2	AN	—	A/D Channel 2 input.
	CPS2	AN	—	Capacitive sensing input 2.
	T0CKI	ST	—	Timer0 clock input.
	INT	ST	—	External interrupt.
	C1OUT	—	CMOS	Comparator C1 output.
	SRQ	—	CMOS	SR Latch non-inverting output.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	FLT0	ST	—	ECCP Auto-Shutdown Fault input.
RA3/T1G(1)/VPP/$\overline{\text{MCLR}}$	RA3	TTL	—	General purpose input.
	T1G	ST	—	Timer1 Gate input.
	VPP	HV	—	Programming voltage.
	$\overline{\text{MCLR}}$	ST	—	Master Clear with internal pull-up.
RA4/AN3/CPS3/OSC2/ CLKOUT/T1OSO/CLKR/$\overline{\text{SS2}}$(1)/ P2B(1)/T1G(1,2)	RA4	TTL	CMOS	General purpose I/O.
	AN3	AN	—	A/D Channel 3 input.
	CPS3	AN	—	Capacitive sensing input 3.
	OSC2	—	CMOS	Comparator C2 output.
	CLKOUT	—	CMOS	FOSC/4 output.
	T1OSO	XTAL	XTAL	Timer1 oscillator connection.
	CLKR	—	CMOS	Clock Reference output.
	$\overline{\text{SS2}}$	ST	—	Slave Select input 2.
	P2B	—	CMOS	PWM output.
	T1G	ST	—	Timer1 Gate input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

TABLE 1-3: PIC16(L)F1829 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RA5/CLKIN/OSC1/T1OSI/ SD02(1)/T1CKI/P2A(1)/CCP2(1)	RA5	TTL	CMOS	General purpose I/O.
	CLKIN	CMOS	—	External clock input (EC mode).
	OSC1	XTAL	—	Crystal/Resonator (LP, XT, HS modes).
	T1OSI	XTAL	XTAL	Timer1 oscillator connection.
	SD02	—	CMOS	SPI data output 2.
	T1CKI	ST	—	Timer1 clock input.
	P2A	—	CMOS	PWM output.
	CCP2	ST	CMOS	Capture/Compare/PWM2.
RB4/AN10/CPS10/SDA1/SDI1	RB4	TTL	CMOS	General purpose I/O.
	AN10	AN	—	A/D Channel 10 input.
	CPS10	AN	—	Capacitive sensing input 10.
	SDA1	I^2C	OD	I^2C™ data input/output.
	SDI1	CMOS	—	SPI data input.
RB5/AN11/CPS11/RX(1,2)/ DT(1,2)/SDA2/SDI2	RB5	TTL	CMOS	General purpose I/O.
	AN11	AN	—	A/D Channel 11 input.
	CPS11	AN	—	Capacitive sensing input 11.
	RX	ST	—	USART asynchronous input.
	DT	ST	CMOS	USART synchronous data.
	SDA2	I^2C	OD	I^2C data input/output 2.
	SDI2	CMOS	—	SPI data input 2.
RB6/SCL1/SCK1	RB6	TTL	CMOS	General purpose I/O.
	SCL1	I^2C	OD	I^2C™ clock 1.
	SCK1	ST	CMOS	SPI clock 1.
RB7/TX(1,2)/CK(1,2)/SCL2/SCK2	RB7	TTL	CMOS	General purpose I/O.
	TX	—	CMOS	USART asynchronous transmit.
	CK	ST	CMOS	USART synchronous clock.
	SCL2	I^2C	OD	I^2C™ clock 2.
	SCK2	ST	CMOS	SPI clock 2.
RC0/AN4/CPS4/C2IN+/P1D(1)/ $\overline{SS2}$(1,2)	RC0	TTL	CMOS	General purpose I/O.
	AN4	AN	—	A/D Channel 4 input.
	CPS4	AN	—	Capacitive sensing input 4.
	C2IN+	AN	—	Comparator C2 positive input.
	P1D	—	CMOS	PWM output.
	$\overline{SS2}$	ST	—	Slave Select input 2.
RC1/AN5/CPS5/C12IN1-/P1C(1)/ SD02(1,2)	RC1	TTL	CMOS	General purpose I/O.
	AN5	AN	—	A/D Channel 5 input.
	CPS5	AN	—	Capacitive sensing input 5.
	C12IN1-	AN	—	Comparator C1 or C2 negative input.
	P1C	—	CMOS	PWM output.
	SDO2	—	CMOS	SPI data output 2.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open Drain
TTL = TTL compatible input; ST = Schmitt Trigger input with CMOS levels; I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage; XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

TABLE 1-3: PIC16(L)F1829 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC2/AN6/CPS6/C12IN2-/ P1D(1,2)/P2B(1,2)/MDCIN1	RC2	TTL	CMOS	General purpose I/O.
	AN6	AN	—	A/D Channel 6 input.
	CPS6	AN	—	Capacitive sensing input 6.
	C12IN2-	AN	—	Comparator C1 or C2 negative input.
	P1D	—	CMOS	PWM output.
	P2B	—	CMOS	PWM output.
	MDCIN1	ST	—	Modulator Carrier Input 1.
RC3/AN7/CPS7/C12IN3-/ P2A(1,2)/CCP2(1,2)/P1C(1,2)/ MDMIN	RC3	TTL	CMOS	General purpose I/O.
	AN7	AN	—	A/D Channel 7 input.
	CPS7	AN	—	Capacitive sensing input 7.
	C12IN3-	AN	—	Comparator C1 or C2 negative input.
	P2A	—	CMOS	PWM output.
	CCP2	AN	—	Capture/Compare/PWM2.
	P1C	—	CMOS	PWM output.
	MDMIN	ST	—	Modulator source input.
RC4/C2OUT/SRNQ/P1B/TX(1)/ CK(1)/MDOUT	RC4	TTL	CMOS	General purpose I/O.
	C2OUT	—	CMOS	Comparator C2 output.
	SRNQ	—	CMOS	SR Latch inverting output.
	P1B	—	CMOS	PWM output.
	TX	—	CMOS	USART asynchronous transmit.
	CK	ST	CMOS	USART synchronous clock.
	MDOUT	—	CMOS	Modulator output.
RC5/P1A/CCP1/DT(1)/RX(1)/ MDCIN2	RC5	TTL	CMOS	General purpose I/O.
	P1A	—	CMOS	PWM output.
	CCP1	ST	CMOS	Capture/Compare/PWM1.
	RX	ST	—	USART asynchronous input.
	DT	ST	CMOS	USART synchronous data.
	MDCIN2	ST	—	Modulator Carrier Input 2.
RC6/AN8/CPS8/CCP4/$\overline{SS1}$	RC6	TTL	CMOS	General purpose I/O.
	AN8	AN	—	A/D Channel 8 input.
	CPS8	AN	—	Capacitive sensing input 8.
	CCP4	AN	—	Capture/Compare/PWM4.
	$\overline{SS1}$	ST	—	Slave Select input.
RC7/AN9/CPS9/SDO1	RC7	TTL	CMOS	General purpose I/O.
	AN9	AN	—	A/D Channel 9 input.
	CPS9	AN	—	Capacitive sensing input 9.
	SDO1	—	CMOS	SPI data output.
VDD	VDD	Power	—	Positive supply.
VSS	VSS	Power	—	Ground reference.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C™ = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Pin functions can be moved using the APFCON0 or APFCON1 register.
2: Default function location.

2.0 ENHANCED MID-RANGE CPU

This family of devices contain an enhanced mid-range 8-bit CPU core. The CPU has 49 instructions. Interrupt capability includes automatic context saving. The hardware stack is 16 levels deep and has Overflow and Underflow Reset capability. Direct, Indirect, and Relative Addressing modes are available. Two File Select Registers (FSRs) provide the ability to read program and data memory.

- Automatic Interrupt Context Saving
- 16-level Stack with Overflow and Underflow
- File Select Registers
- Instruction Set

2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See **Section 8.5 "Automatic Context Saving"**, for more information.

2.2 16-level Stack with Overflow and Underflow

These devices have an external stack memory 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled will cause a software Reset. See section **Section 3.4 "Stack"** for more details.

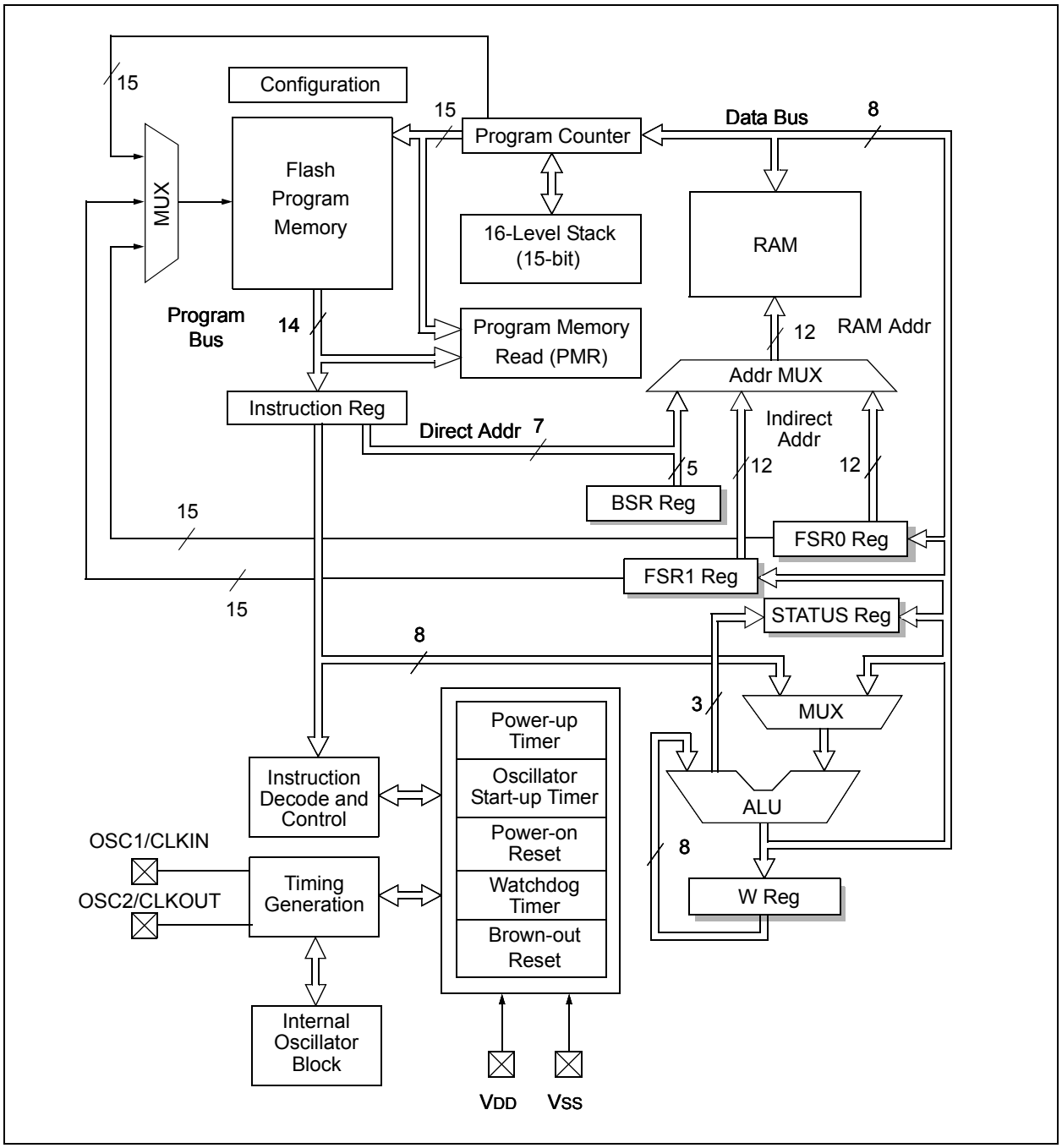
2.3 File Select Registers

There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is one additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See **Section 3.5 "Indirect Addressing"** for more details.

2.4 Instruction Set

There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See **Section 29.0 "Instruction Set Summary"** for more details.

FIGURE 2-1: CORE BLOCK DIAGRAM



3.0 MEMORY ORGANIZATION

These devices contain the following types of memory:

- Program Memory
  - Configuration Words
  - Device ID
  - User ID
  - Flash Program Memory
- Data Memory
  - Core Registers
  - Special Function Registers
  - General Purpose RAM
  - Common RAM
- Data EEPROM memory(1)

Note 1: The Data EEPROM Memory and the method to access Flash memory through the EECON registers is described in **Section 11.0 "Data EEPROM and Flash Program Memory Control"**.

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing

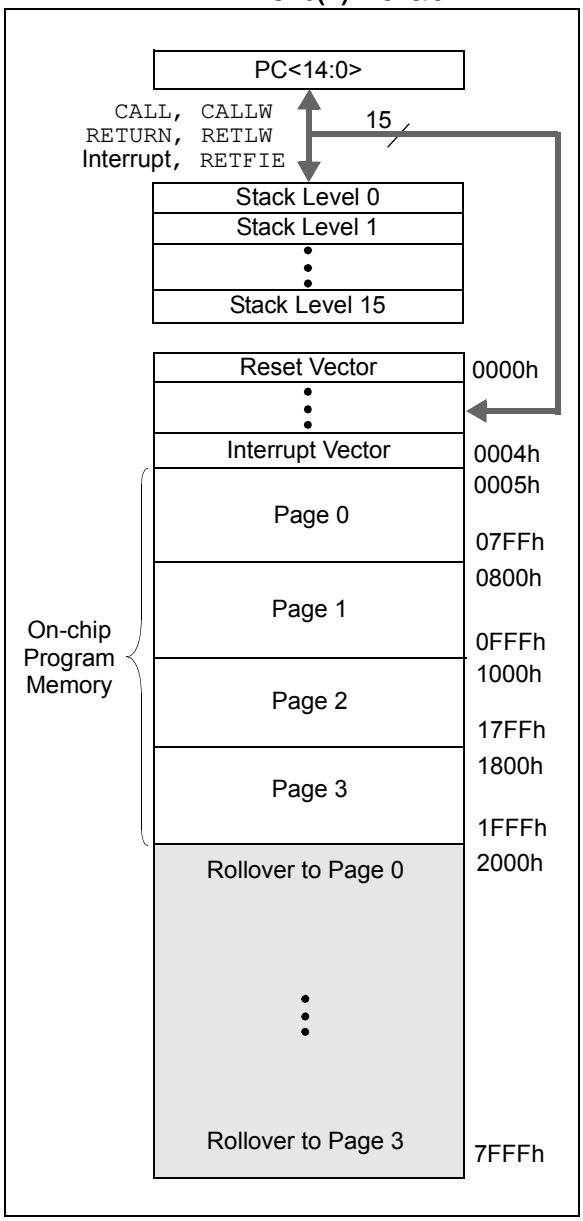
3.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing 32K x 14 program memory space. Table 3-1 shows the memory sizes implemented for the PIC16(L)F1825/9 family. Accessing a location above these boundaries will cause a wrap-around within the implemented memory space. The Reset vector is at 0000h and the interrupt vector is at 0004h (See Figure 3-1).

TABLE 3-1: DEVICE SIZES AND ADDRESSES

Device	Program Memory Space (Words)	Last Program Memory Address
PIC16(L)F1825 PIC16(L)F1829	8,192	7FFFh

FIGURE 3-1: PROGRAM MEMORY MAP AND STACK FOR PIC16(L)F1825/9



3.1.1 READING PROGRAM MEMORY AS DATA

There are two methods of accessing constants in program memory. The first method is to use tables of `RETLW` instructions. The second method is to set an FSR to point to the program memory.

3.1.1.1 `RETLW` Instruction

The `RETLW` instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 3-1.

EXAMPLE 3-1: `RETLW` INSTRUCTION

```
constants
    BRW                 ;Add Index in W to
                        ;program counter to
                        ;select data
    RETLW DATA0         ;Index0 data
    RETLW DATA1         ;Index1 data
    RETLW DATA2
    RETLW DATA3


my_function
    ;… LOTS OF CODE…
    MOVLW       DATA_INDEX
    call constants
    ;… THE CONSTANT IS IN W
```

The `BRW` instruction makes this type of table very simple to implement. If your code must remain portable with previous generations of microcontrollers, then the `BRW` instruction is not available so the older table read method must be used.

3.1.1.2 Indirect Read with FSR

The program memory can be accessed as data by setting bit 7 of the FSRxH register and reading the matching INDFx register. The MOVIW instruction will place the lower eight bits of the addressed word in the W register. Writes to the program memory cannot be performed via the INDF registers. Instructions that access the program memory via the FSR require one extra instruction cycle to complete. Example 3-2 demonstrates accessing the program memory via an FSR.

The High directive will set bit<7> if a label points to a location in program memory.

EXAMPLE 3-2: ACCESSING PROGRAM MEMORY VIA FSR

```
constants
    RETLW DATA0         ;Index0 data
    RETLW DATA1         ;Index1 data
    RETLW DATA2
    RETLW DATA3
my_function
    ;… LOTS OF CODE…
    MOVLW   LOW constants
    MOVWF   FSR1L
    MOVLW   HIGH constants
    MOVWF   FSR1H
    MOVIW   0[FSR1]
;THE PROGRAM MEMORY IS IN W
```

3.2 Data Memory Organization

The data memory is partitioned in 32 memory banks with 128 bytes in a bank. Each bank consists of (Figure 3-2):

- 12 core registers
- 20 Special Function Registers (SFR)
- Up to 80 bytes of General Purpose RAM (GPR)
- 16 bytes of common RAM

The active bank is selected by writing the bank number into the Bank Select Register (BSR). Unimplemented memory will read as '0'. All data memory can be accessed either directly (via instructions that use the file registers) or indirectly via the two File Select Registers (FSR). See **Section 3.5 "Indirect Addressing"** for more information.

Data Memory uses a 12-bit address. The upper seven bits of the address define the Bank address and the lower five bits select the registers/RAM in that bank.

3.2.1 CORE REGISTERS

The core registers contain the registers that directly affect the basic operation of the PIC16(L)F1825/9. These registers are listed below:

- INDF0
- INDF1
- PCL
- STATUS
- FSR0 Low
- FSR0 High
- FSR1 Low
- FSR1 High
- BSR
- WREG
- PCLATH
- INTCON

Note: The core registers are the first 12 addresses of every data memory bank.

3.2.1.1 STATUS Register

The STATUS register, shown in Register 3-1, contains:

- the arithmetic status of the ALU
- the Reset status

The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper three bits and set the Z bit. This leaves the STATUS register as '`000u u1uu`' (where `u` = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits (Refer to **Section 29.0 "Instruction Set Summary"**).

Note 1: The C and DC bits operate as $\overline{Borrow}$ and $\overline{Digit\ Borrow}$ out bits, respectively, in subtraction.

REGISTER 3-1: STATUS: STATUS REGISTER

U-0	U-0	U-0	R-1/q	R-1/q	R/W-0/u	R/W-0/u	R/W-0/u
—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC(1)	C(1)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **$\overline{TO}$:** Time-out bit
1 = After power-up, `CLRWDT` instruction or `SLEEP` instruction
0 = A WDT time-out occurred

bit 3 **$\overline{PD}$:** Power-down bit
1 = After power-up or by the `CLRWDT` instruction
0 = By execution of the `SLEEP` instruction

bit 2 **Z:** Zero bit
1 = The result of an arithmetic or logic operation is zero
0 = The result of an arithmetic or logic operation is not zero

bit 1 **DC:** Digit Carry/$\overline{Digit\ Borrow}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(1)
1 = A carry-out from the 4th low-order bit of the result occurred
0 = No carry-out from the 4th low-order bit of the result

bit 0 **C:** Carry/$\overline{Borrow}$ bit(1) (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)(1)
1 = A carry-out from the Most Significant bit of the result occurred
0 = No carry-out from the Most Significant bit of the result occurred

Note 1: For $\overline{Borrow}$, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (`RRF`, `RLF`) instructions, this bit is loaded with either the high-order or low-order bit of the source register.

3.2.2 SPECIAL FUNCTION REGISTER

The Special Function Registers (FSR) are registers used by the application to control the desired operation of peripheral functions in the device. The Special Function Registers occupy the 20 bytes after the core registers of every data memory bank (addresses x0Ch/x8Ch through x1Fh/x9Fh). The registers associated with the operation of the peripherals are described in the appropriate peripheral chapter of this data sheet.

3.2.3 GENERAL PURPOSE RAM

There are up to 80 bytes of GPR in each data memory bank. The Special Function Registers occupy the 20 bytes after the core registers of every data memory bank (addresses x0Ch/x8Ch through x1Fh/x9Fh).

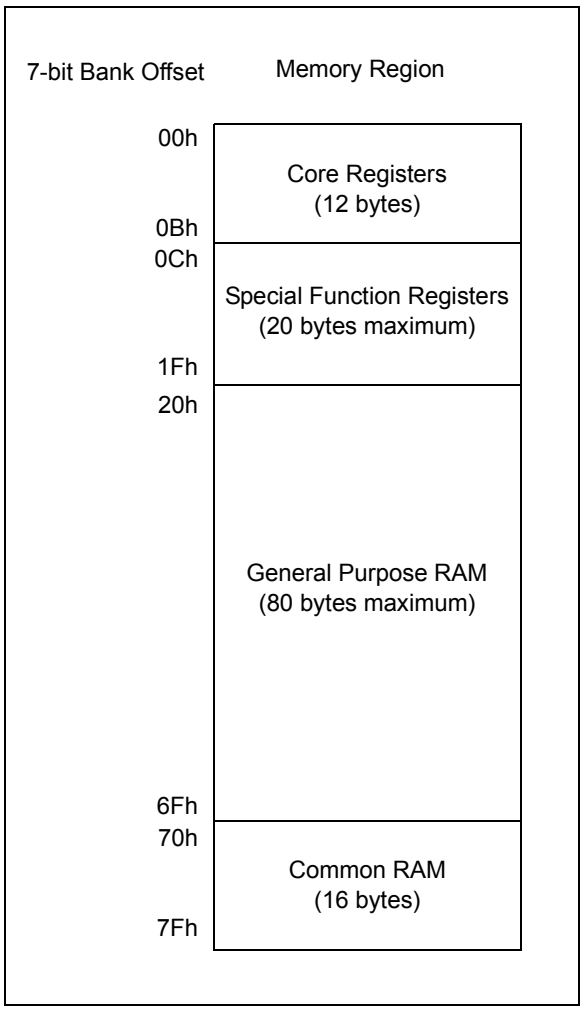
3.2.3.1 Linear Access to GPR

The general purpose RAM can be accessed in a non-banked method via the FSRs. This can simplify access to large memory structures. See **Section 3.5.2 "Linear Data Memory"** for more information.

3.2.4 COMMON RAM

There are 16 bytes of common RAM accessible from all banks.

FIGURE 3-2: BANKED MEMORY PARTITIONING



3.2.5 DEVICE MEMORY MAPS

The memory maps for the device family are as shown in Table 3-2.

TABLE 3-2: MEMORY MAP TABLES

Device	Banks	Table No.
PIC16(L)F1825 PIC16(L)F1829	0-7	Table 3-3
	8-15	Table 3-4
	16-23	Table 3-5
	24-31	Table 3-6
	31	Table 3-7

TABLE 3-3: PIC16(L)F1825/9 MEMORY MAP, BANKS 0-7

	BANK 0		BANK 1		BANK 2		BANK 3		BANK 4		BANK 5		BANK 6		BANK 7	
000h	INDF0	080h	INDF0	100h	INDF0	180h	INDF0	200h	INDF0	280h	INDF0	300h	INDF0	380h	INDF0
001h	INDF1	081h	INDF1	101h	INDF1	181h	INDF1	201h	INDF1	281h	INDF1	301h	INDF1	381h	INDF1
002h	PCL	082h	PCL	102h	PCL	182h	PCL	202h	PCL	282h	PCL	302h	PCL	382h	PCL
003h	STATUS	083h	STATUS	103h	STATUS	183h	STATUS	203h	STATUS	283h	STATUS	303h	STATUS	383h	STATUS
004h	FSR0L	084h	FSR0L	104h	FSR0L	184h	FSR0L	204h	FSR0L	284h	FSR0L	304h	FSR0L	384h	FSR0L
005h	FSR0H	085h	FSR0H	105h	FSR0H	185h	FSR0H	205h	FSR0H	285h	FSR0H	305h	FSR0H	385h	FSR0H
006h	FSR1L	086h	FSR1L	106h	FSR1L	186h	FSR1L	206h	FSR1L	286h	FSR1L	306h	FSR1L	386h	FSR1L
007h	FSR1H	087h	FSR1H	107h	FSR1H	187h	FSR1H	207h	FSR1H	287h	FSR1H	307h	FSR1H	387h	FSR1H
008h	BSR	088h	BSR	108h	BSR	188h	BSR	208h	BSR	288h	BSR	308h	BSR	388h	BSR
009h	WREG	089h	WREG	109h	WREG	189h	WREG	209h	WREG	289h	WREG	309h	WREG	389h	WREG
00Ah	PCLATH	08Ah	PCLATH	10Ah	PCLATH	18Ah	PCLATH	20Ah	PCLATH	28Ah	PCLATH	30Ah	PCLATH	38Ah	PCLATH
00Bh	INTCON	08Bh	INTCON	10Bh	INTCON	18Bh	INTCON	20Bh	INTCON	28Bh	INTCON	30Bh	INTCON	38Bh	INTCON
00Ch	PORTA	08Ch	TRISA	10Ch	LATA	18Ch	ANSELA	20Ch	WPUA	28Ch	—	30Ch	—	38Ch	INLVLA
00Dh	PORTB(1)	08Dh	TRISB(1)	10Dh	LATB(1)	18Dh	ANSELB(1)	20Dh	WPUB(1)	28Dh	—	30Dh	—	38Dh	INLVLB(1)
00Eh	PORTC	08Eh	TRISC	10Eh	LATC	18Eh	ANSELC	20Eh	WPUC	28Eh	—	30Eh	—	38Eh	INLVLC
00Fh	—	08Fh	—	10Fh	—	18Fh	—	20Fh	—	28Fh	—	30Fh	—	38Fh	—
010h	—	090h	—	110h	—	190h	—	210h	—	290h	—	310h	—	390h	—
011h	PIR1	091h	PIE1	111h	CM1CON0	191h	EEADRL	211h	SSP1BUF	291h	CCPR1L	311h	CCPR3L	391h	IOCAP
012h	PIR2	092h	PIE2	112h	CM1CON1	192h	EEADRH	212h	SSP1ADD	292h	CCPR1H	312h	CCPR3H	392h	IOCAN
013h	PIR3	093h	PIE3	113h	CM2CON0	193h	EEDATL	213h	SSP1MSK	293h	CCP1CON	313h	CCP3CON	393h	IOCAF
014h	PIR4(1)	094h	PIE4(1)	114h	CM2CON1	194h	EEDATH	214h	SSP1STAT	294h	PWM1CON	314h	—	394h	IOCBP(1)
015h	TMR0	095h	OPTION_REG	115h	CMOUT	195h	EECON1	215h	SSP1CON1	295h	CCP1AS	315h	—	395h	IOCBN(1)
016h	TMR1L	096h	PCON	116h	BORCON	196h	EECON2	216h	SSP1CON2	296h	PSTR1CON	316h	—	396h	IOCBF(1)
017h	TMR1H	097h	WDTCON	117h	FVRCON	197h	—	217h	SSP1CON3	297h	—	317h	—	397h	—
018h	T1CON	098h	OSCTUNE	118h	DACCON0	198h	—	218h	—	298h	CCPR2L	318h	CCPR4L	398h	—
019h	T1GCON	099h	OSCCON	119h	DACCON1	199h	RCREG	219h	SSP2BUF(1)	299h	CCPR2H	319h	CCPR4H	399h	—
01Ah	TMR2	09Ah	OSCSTAT	11Ah	SRCON0	19Ah	TXREG	21Ah	SSP2ADD(1)	29Ah	CCP2CON	31Ah	CCP4CON	39Ah	CLKRCON
01Bh	PR2	09Bh	ADRESL	11Bh	SRCON1	19Bh	SPBRGL	21Bh	SSP2MSK(1)	29Bh	PWM2CON	31Bh	—	39Bh	—
01Ch	T2CON	09Ch	ADRESH	11Ch	—	19Ch	SPBRGH	21Ch	SSP2STAT(1)	29Ch	CCP2AS	31Ch	—	39Ch	MDCON
01Dh	—	09Dh	ADCON0	11Dh	APFCON0	19Dh	RCSTA	21Dh	SSP2CON1(1)	29Dh	PSTR2CON	31Dh	—	39Dh	MDSRC
01Eh	CPSCON0	09Eh	ADCON1	11Eh	APFCON1	19Eh	TXSTA	21Eh	SSP2CON2(1)	29Eh	CCPTMRS	31Eh	—	39Eh	MDCARL
01Fh	CPSCON1	09Fh	—	11Fh	—	19Fh	BAUDCON	21Fh	SSP2CON3(1)	29Fh	—	31Fh	—	39Fh	MDCARH
020h	General Purpose Register 96 Bytes	0A0h	General Purpose Register 80 Bytes	120h	General Purpose Register 80 Bytes	1A0h	General Purpose Register 80 Bytes	220h	General Purpose Register 80 Bytes	2A0h	General Purpose Register 80 Bytes	320h	General Purpose Register 80 Bytes	3A0h	General Purpose Register 80 Bytes
06Fh		0EFh		16Fh		1EFh		26Fh		2EFh		36Fh		3EFh	
070h	Common RAM	0F0h	Accesses 70h – 7Fh	170h	Accesses 70h – 7Fh	1F0h	Accesses 70h – 7Fh	270h	Accesses 70h – 7Fh	2F0h	Accesses 70h – 7Fh	370h	Accesses 70h – 7Fh	3F0h	Accesses 70h – 7Fh
07Fh		0FFh		17Fh		1FFh		27Fh		2FFh		37Fh		3FFh	

Legend: = Unimplemented data memory locations, read as '0'

Note 1: Available only on PIC16(L)F1829.

TABLE 3-4: PIC16(L)F1825/9 MEMORY MAP, BANKS 8-15

BANK 8		BANK 9		BANK 10		BANK 11		BANK 12		BANK 13		BANK 14		BANK 15	
400h	INDF0	480h	INDF0	500h	INDF0	580h	INDF0	600h	INDF0	680h	INDF0	700h	INDF0	780h	INDF0
401h	INDF1	481h	INDF1	501h	INDF1	581h	INDF1	601h	INDF1	681h	INDF1	701h	INDF1	781h	INDF1
402h	PCL	482h	PCL	502h	PCL	582h	PCL	602h	PCL	682h	PCL	702h	PCL	782h	PCL
403h	STATUS	483h	STATUS	503h	STATUS	583h	STATUS	603h	STATUS	683h	STATUS	703h	STATUS	783h	STATUS
404h	FSR0L	484h	FSR0L	504h	FSR0L	584h	FSR0L	604h	FSR0L	684h	FSR0L	704h	FSR0L	784h	FSR0L
405h	FSR0H	485h	FSR0H	505h	FSR0H	585h	FSR0H	605h	FSR0H	685h	FSR0H	705h	FSR0H	785h	FSR0H
406h	FSR1L	486h	FSR1L	506h	FSR1L	586h	FSR1L	606h	FSR1L	686h	FSR1L	706h	FSR1L	786h	FSR1L
407h	FSR1H	487h	FSR1H	507h	FSR1H	587h	FSR1H	607h	FSR1H	687h	FSR1H	707h	FSR1H	787h	FSR1H
408h	BSR	488h	BSR	508h	BSR	588h	BSR	608h	BSR	688h	BSR	708h	BSR	788h	BSR
409h	WREG	489h	WREG	509h	WREG	589h	WREG	609h	WREG	689h	WREG	709h	WREG	789h	WREG
40Ah	PCLATH	48Ah	PCLATH	50Ah	PCLATH	58Ah	PCLATH	60Ah	PCLATH	68Ah	PCLATH	70Ah	PCLATH	78Ah	PCLATH
40Bh	INTCON	48Bh	INTCON	50Bh	INTCON	58Bh	INTCON	60Bh	INTCON	68Bh	INTCON	70Bh	INTCON	78Bh	INTCON
40Ch	—	48Ch	—	50Ch	—	58Ch	—	60Ch	—	68Ch	—	70Ch	—	78Ch	—
40Dh	—	48Dh	—	50Dh	—	58Dh	—	60Dh	—	68Dh	—	70Dh	—	78Dh	—
40Eh	—	48Eh	—	50Eh	—	58Eh	—	60Eh	—	68Eh	—	70Eh	—	78Eh	—
40Fh	—	48Fh	—	50Fh	—	58Fh	—	60Fh	—	68Fh	—	70Fh	—	78Fh	—
410h	—	490h	—	510h	—	590h	—	610h	—	690h	—	710h	—	790h	—
411h	—	491h	—	511h	—	591h	—	611h	—	691h	—	711h	—	791h	—
412h	—	492h	—	512h	—	592h	—	612h	—	692h	—	712h	—	792h	—
413h	—	493h	—	513h	—	593h	—	613h	—	693h	—	713h	—	793h	—
414h	—	494h	—	514h	—	594h	—	614h	—	694h	—	714h	—	794h	—
415h	TMR4	495h	—	515h	—	595h	—	615h	—	695h	—	715h	—	795h	—
416h	PR4	496h	—	516h	—	596h	—	616h	—	696h	—	716h	—	796h	—
417h	T4CON	497h	—	517h	—	597h	—	617h	—	697h	—	717h	—	797h	—
418h	—	498h	—	518h	—	598h	—	618h	—	698h	—	718h	—	798h	—
419h	—	499h	—	519h	—	599h	—	619h	—	699h	—	719h	—	799h	—
41Ah	—	49Ah	—	51Ah	—	59Ah	—	61Ah	—	69Ah	—	71Ah	—	79Ah	—
41Bh	—	49Bh	—	51Bh	—	59Bh	—	61Bh	—	69Bh	—	71Bh	—	79Bh	—
41Ch	TMR6	49Ch	—	51Ch	—	59Ch	—	61Ch	—	69Ch	—	71Ch	—	79Ch	—
41Dh	PR6	49Dh	—	51Dh	—	59Dh	—	61Dh	—	69Dh	—	71Dh	—	79Dh	—
41Eh	T6CON	49Eh	—	51Eh	—	59Eh	—	61Eh	—	69Eh	—	71Eh	—	79Eh	—
41Fh	—	49Fh	—	51Fh	—	59Fh	—	61Fh	—	69Fh	—	71Fh	—	79Fh	—
420h	General Purpose Register 80 Bytes	4A0h	General Purpose Register 80 Bytes	520h	General Purpose Register 80 Bytes	5A0h	General Purpose Register 80 Bytes	620h	General Purpose Register 48 Bytes	6A0h	Unimplemented Read as '0'	720h	Unimplemented Read as '0'	7A0h	Unimplemented Read as '0'
46Fh		4EFh		56Fh		5EFh		64Fh		6EFh		76Fh		7EFh	
470h	Accesses 70h – 7Fh	4F0h	Accesses 70h – 7Fh	570h	Accesses 70h – 7Fh	5F0h	Accesses 70h – 7Fh	650h	Unimplemented Read as '0'	6F0h	Accesses 70h – 7Fh	770h	Accesses 70h – 7Fh	7F0h	Accesses 70h – 7Fh
47Fh		4FFh		57Fh		5FFh		66Fh		6FFh		77Fh		7FFh	

Legend: = Unimplemented data memory locations, read as '0'